优尚

YOUSHANG SEMICONDUCTOR

设计研发新型功率器件

各类小信号开关

中低压及高压大电流等场效应管

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Features

- BV_{CEO} > 20V
- I_C = 2.5A Continuous Collector Current
- $R_{CE(sat)}$ = 50mΩ for a low equivalent On-Resistance
- 625mW Power dissipation
- h_{FE} characterized up to 6A for high current gain hold up
- Complementary NPN type: NK-FMMT718Q

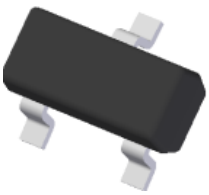
Mechanical Data

- Package: SOT23
- Package Material: molded plastic, “Green” molding compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 e3
- Weight 0.008 grams (Approximate)

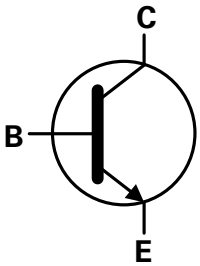
Applications

- DC-DC Modules
- Gate Driver
- LED Driver

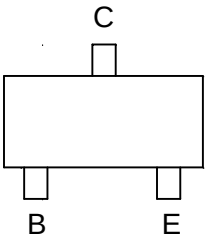
SOT23



Top View



Device Symbol



Top View
Pin-Out

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	20	V
Collector-Emitter Voltage	V_{CEO}	20	V
Emitter-Base Voltage	V_{EBO}	7	V
Continuous Collector Current	I_C	2.5	A
Peak Pulse Current	I_{CM}	6	A
Base Current	I_B	500	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	625	mW
Power Dissipation (Note 6)	P_D	806	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	155	°C/W
Thermal Resistance, Junction to Leads (Note 7)	$R_{\theta JL}$	194	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Notes:
5. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
6. Same as note 6, except the device is measured at t ≤ 5 sec.
7. Thermal resistance from junction to solder-point (at the end of the collector lead).

Thermal Characteristics and Derating information

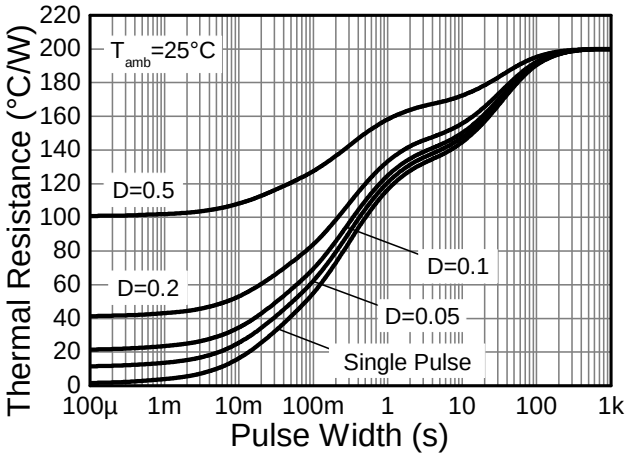


Fig. 1 Transient Thermal Impedance

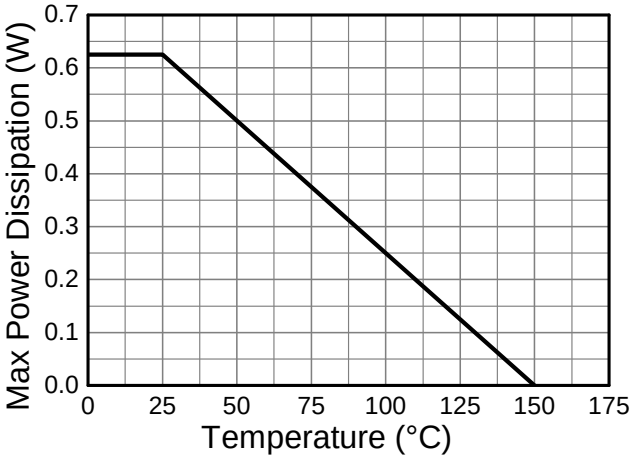


Fig. 2 Derating Curve

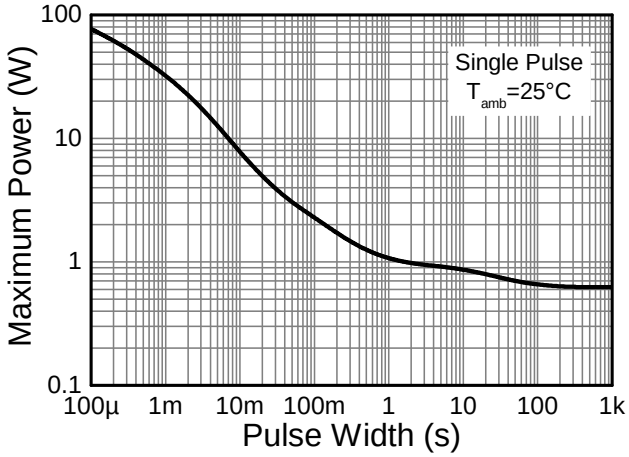


Fig. 3 Pulse Power Dissipation

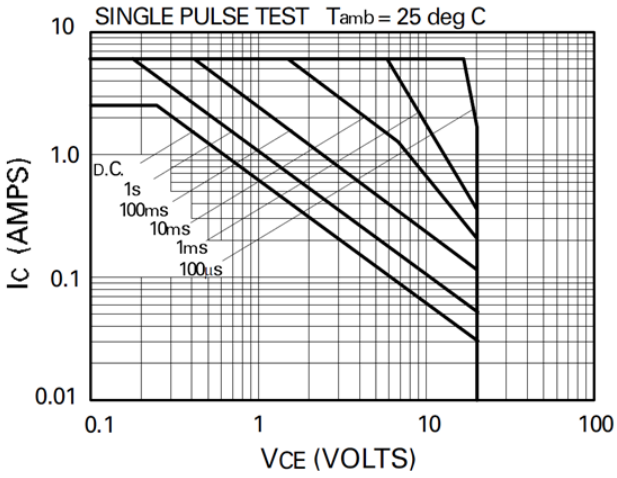


Fig. 4 Safe Operating Area

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_{CBO}	20	100	-	V	I_C = 100μA
Collector-Emitter Breakdown Voltage (Note 8)	BV_{CEO}	20	27	-	V	I_C = 10mA
Emitter-Base Breakdown Voltage	BV_{EBO}	7	8.3	-	V	I_E = 100μA
Collector Cut-off Current	I_{CBO}	-	-	100	nA	V_{CB} =20V
Emitter Cut-off Current	I_{EBO}	-	-	100	nA	V_{EB} = 4V
Collector Emitter Cut-off Current	I_{CES}	-	-	100	nA	V_{CES} =20V
Static Forward Current Transfer Ratio (Note 8)	h_{FE}	200 300 200 100	400 450 340 150	- - - -	-	I_C = 10mA, V_{CE} = 2V I_C = 200mA, V_{CE} = 2V I_C = 2A, V_{CE} = 2V I_C = 6A, V_{CE} = 2V
Collector-Emitter Saturation Voltage (Note 8)	$V_{CE(sat)}$	- - -	8 70 130	15 150 200	mV	I_C =0.1A, I_B = 10mA I_C =1A, I_B = 10mA I_C =2.5A, I_B = 50mA
Base-Emitter Saturation Voltage (Note 8)	$V_{BE(sat)}$	-	0.89	1	V	I_C =2.5A, I_B = 50mA
Base-Emitter Saturation Voltage (Note 8)	$V_{BE(on)}$	-	0.83	1	V	I_C =2.5A, V_{CE} = 2V
Transition Frequency	f_T	100	140	-	MHz	I_C = 50mA, V_{CE} = 10V, f=100MHz
Collector Output Capacitance	C_{obo}	-	23	30	pF	V_{CB} = 10V, f=1MHz
Turn-On Time	t_{on}	-	170	-	ns	V_{CC} = 10V, I_C = 1A, I_{B1} = -I_{B2} = 10mA
Turn-Off Time	t_{off}	-	400	-	ns	

Note: 8. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%

Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

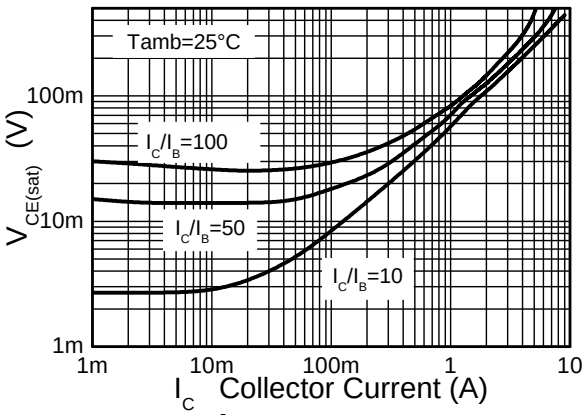


Fig.5 $V_{CE(sat)}$ v I_C

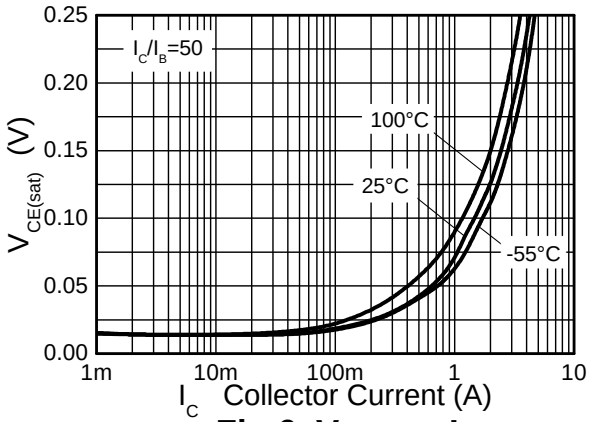


Fig.6 $V_{CE(sat)}$ v I_C

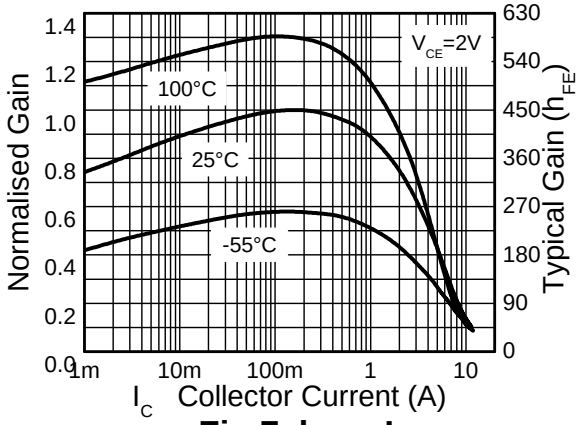


Fig.7 h_{FE} v I_C

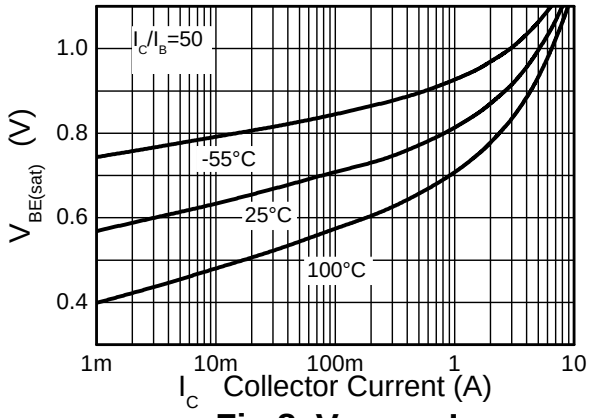


Fig.8 $V_{BE(sat)}$ v I_C

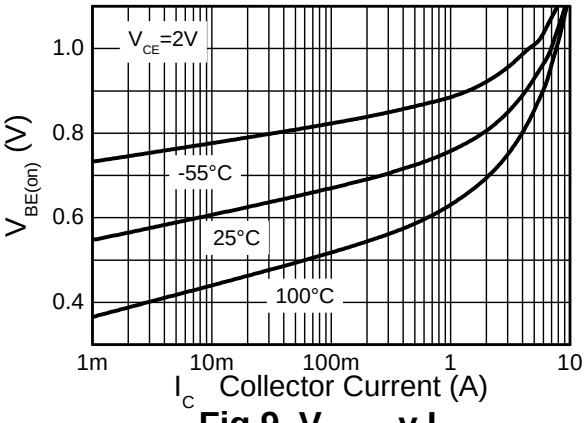


Fig.9 $V_{BE(on)}$ v I_C

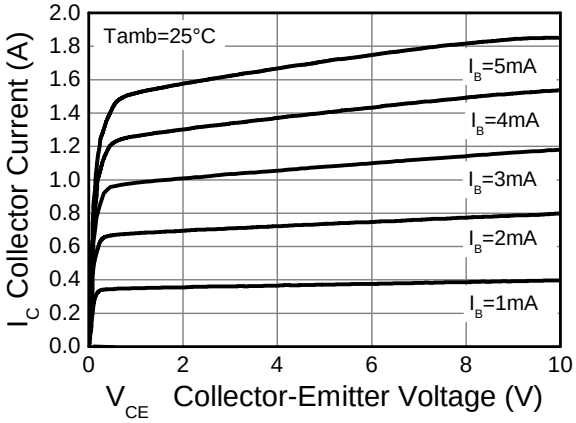
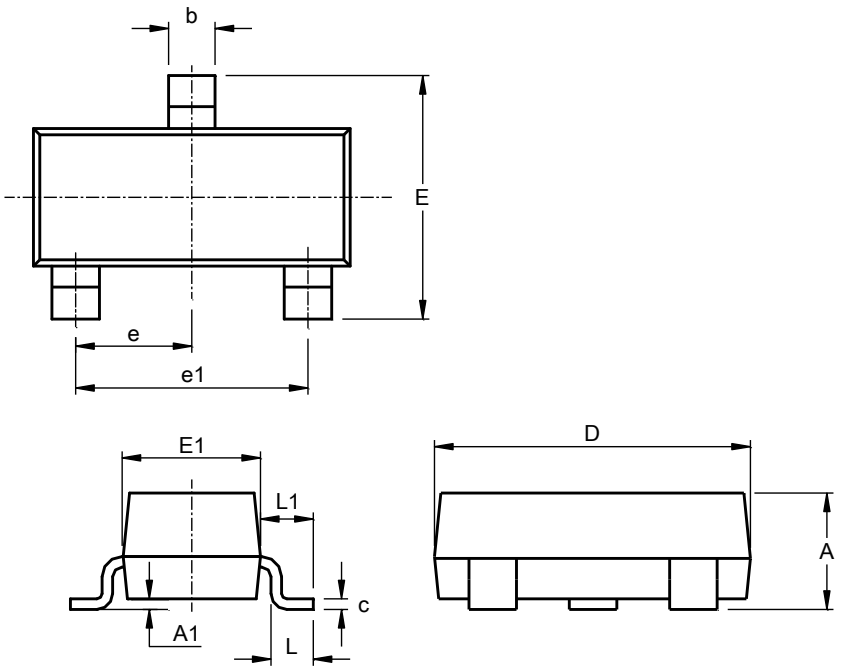


Fig.10 I_C v V_{CE}

Package Outline Dimensions

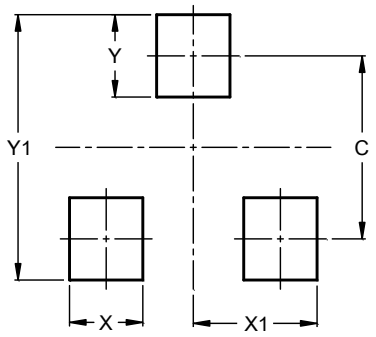
SOT23 (Type DN)



SOT23 (Type DN)			
Dim	**Min**	**Max**	**Typ**
A	0.89	1.12	1.00
A1	0.01	0.10	0.05
b	0.30	0.51	0.45
c	0.08	0.20	0.10
D	2.80	3.04	3.00
E	2.10	2.64	2.42
E1	1.20	1.40	1.37
e	0.95 REF		
e1	1.90 REF		
L	0.25	0.60	0.30
L1	0.45	0.62	0.54
All Dimensions in mm			

Suggested Pad Layout

SOT23 (Type DN)



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9